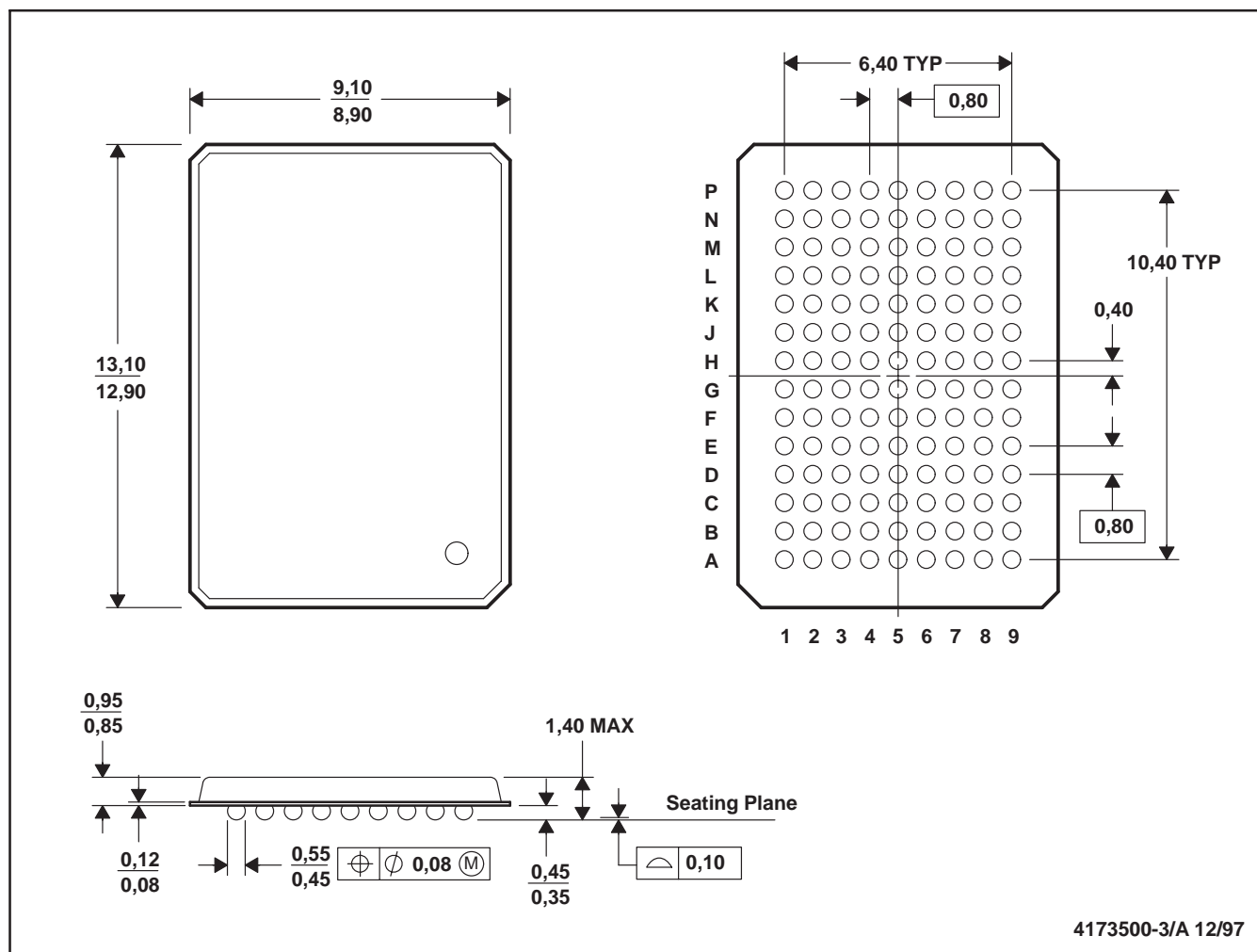


## GHN (R-PBGA-N126)

## PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Micro Star™ BGA configuration

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